

Surface Mount - 600 - 800V > BTB08-600CW3G, BTB08-800CW3G

BTB08-600CW3G, BTB08-800CW3G



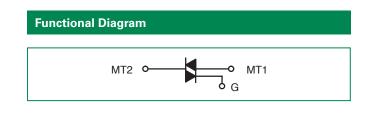
Description

Designed for high performance full-wave ac control applications where high noise immunity and high commutating di/dt are required.

Po

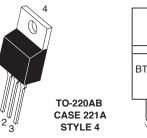
Features

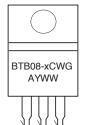
- Blocking Voltage to 800 V
- On-State Current Rating of 8 A RMS at 80°C
- Uniform Gate Trigger Currents in Three Quadrants
- High Immunity to dV/dt 1500 V/s minimum at 125°C
- Minimizes Snubber Networks for Protection
- Industry Standard TO-220AB Package
- High Commutating dl/dt 3.0 A/ms minimum at 125°C
- These Devices are Pb-Free





Pin Out







Maximum Ratings † (T _J = 25°C unless otherwise noted)					
Rating	Part Number	Symbol	Value	Unit	
Peak Repetitive Off-State Voltage (Note 1)	BTB08-600CW3G	V _{drm,} V _{rrm}	600	V	
$(T_{J} = -40 \text{ to } 125^{\circ}\text{C}$, Sine Wave, 50 to 60 Hz, Gate Open)	BTB08-800CW3G		800	v	
On-State RMS Current (Full Cycle Sine Wave, 60 Hz, TC = 80°C)		I _{T (RMS)}	8.0	A	
Peak Non–Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz,T _c = 25°C)			90	А	
Circuit Fusing Considerations (t = 10 ms)			36	A ² sec	
Non–Repetitive Surge Peak Off–State Voltage ($T_J = 25^{\circ}C$, t = 10ms)			V _{DRM} /V _{RRM} +100	V	
Peak Gate Current (T _J = 125°C, t = 20ms)			4.0	А	
Peak Gate Power (Pulse Width \leq 1.0 µs, TC = 80°C)			20	W	
Average Gate Power ($T_J = 125^{\circ}C$)			1.0	W	
Operating Junction Temperature Range			-40 to +125	°C	
Storage Temperature Range		T _{stg}	-40 to +150	°C	

† Indicates JEDEC Registered Data

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Maximum Ratings † ($T_{J} = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (AC)	R _{ejc}	2.5	°C/W
Thermal Resistance, Junction-to-Ambient	R _{eJA}	60	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	TL	260	°C

† Indicates JEDEC Registered Data



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Electrical Characteristics · **OFF** ($T_c = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Blocking Current	$T_J = 25^{\circ}C$	I _{DRM} ,	-	-	0.005	mA
$(V_{D} = V_{DRM} = V_{RRM}; Gate Open)$	T _J = 125°C	I _{RRM}	-	-	1.0	ШA

Electrical Characteristics - ON

Characteristic		Symbol	Min	Тур	Max	Unit
Peak On-State Voltage (Note 2) (I _{TM} = ±11 A Peak)		V _{TM}	-	_	1.55	V
	MT2(+), G(+)		2.5	_	35	
Gate Trigger Current (Continuous dc) (V $_{\rm D}$ = 12 V, R $_{\rm L}$ = 30 Ω)	MT2(+), G(-)	I _{GT}	2.5	-	35	mA
	MT2(-), G(-)		2.5	-	35	
Holding Current ($V_D = 12 V$, Gate Open, Initiating Current = ±100 mA)	I _H	_	_	45	mA
	MT2(+), G(+)		-	_	50	
Latching Current ($V_{D} = 24 \text{ V}, \text{ I}_{G} = 42 \text{ mA}$)	MT2(+), G(-)	l I _L	_	_	80	mA
	MT2(-), G(-)		-	-	50	
	MT2(+), G(+)		0.5	_	1.7	
Gate Trigger Voltage ($V_D = 12 \text{ V}, \text{ R}_L = 30 \Omega$)	MT2(+), G(-)	V _{gt}	0.5	-	1.1	V
	MT2(-), G(-)		0.5	-	1.1	
	MT2(+), G(+)		0.2	-	-	
Gate Non-Trigger Voltage $(T_J = 125^{\circ}C)$	MT2(+), G(-)	V _{gd}	0.2	-	-	V
	MT2(-), G(-)		0.2	_	_	

2. Indicates Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%.



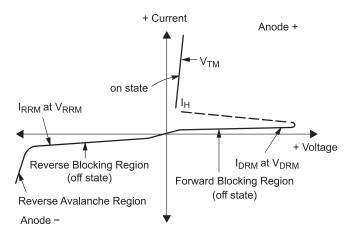
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Dynamic Characteristics

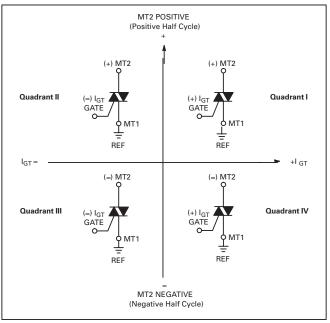
Characteristic	Symbol	Min	Тур	Max	Unit
Rate of Change of Commutating Current, See Figure 10. (Gate Open, TJ = 125°C, No Snubber)	(dl/dt) _c	3.0	_	_	A/ms
Critical Rate of Rise of On-State Current (TJ = 125°C, f = 120 Hz, IG = 2 x IGT, tr \leq 100 ns)	dl/dt	-	_	50	A/µs
Critical Rate–of–Rise of Off-State Voltage ($V_D = 0.66 \times V_{DRM'}$ Exponential Waveform, Gate Open, $T_J = 125^{\circ}$ C)	dv/dt(c)	1500	_	_	V/µs

Voltage Current Characteristic of SCR

Symbol	Parameter
V _{drm}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current



Quadrant Definitions for a Triac



All polarities are referenced to MT1. With in-phase signals (using standard AC lines) quadrants I and III are used.



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Figure 1. RMS Current Derating

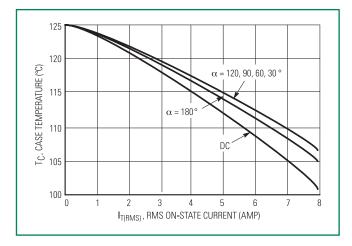


Figure 3. On–State Characteristics

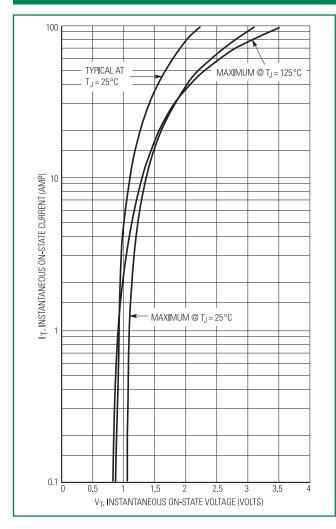


Figure 2. On-State Power Dissipation

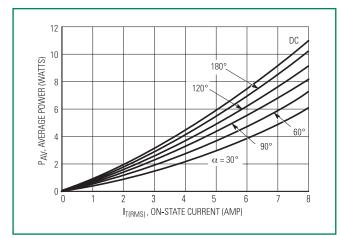


Figure 4. Thermal Response

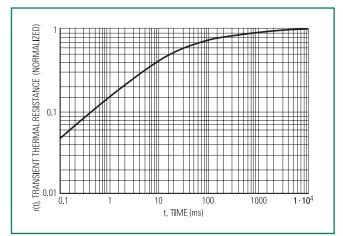
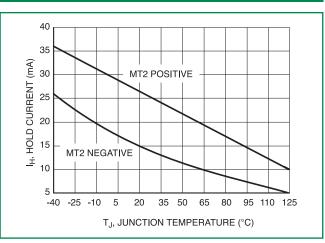


Figure 5. Typical Hold Current Variation





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Typical Characteristics

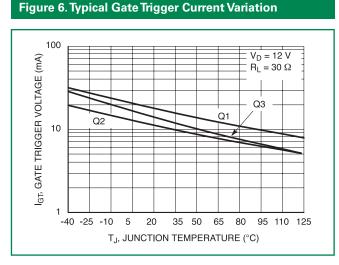


Figure 8. Critial Rate of Rise of Off-State Voltage (Exponential Waveform)

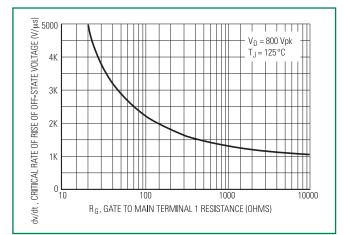


Figure 7. Typical Gate Trigger Current Variation

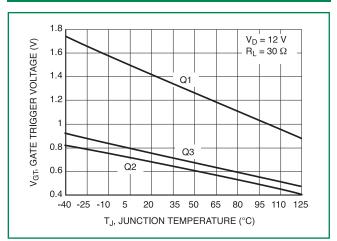
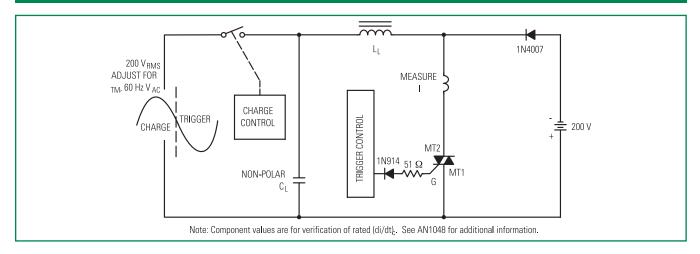


Figure 9. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current (di/dt)_c



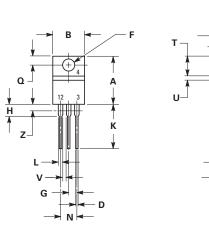


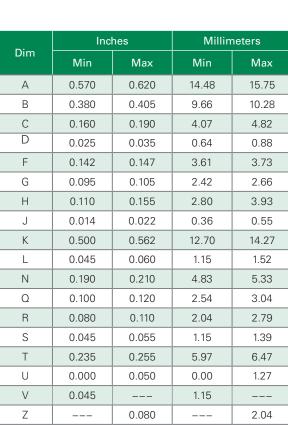
-T- SEATING PLANE

S

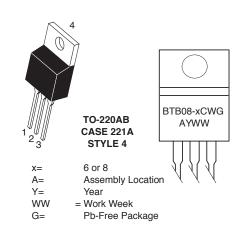
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Dimensions





Part Marking System



Pin Assignment	
1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	Main Terminal 2

Ordering Information

Device	Package	Shipping
BTB08-600CW3G	TO-220AB	EQ Unita / Potail
BTB08-800CW3G	(Pb-Free)	50 Units / Retail

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND

LEAD IRREGULARITIES ARE ALLOWED.

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